

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,036,910 B2
APPLICATION NO. : 10/670398
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INVENTOR(S) : Tetsuya Ohashi et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

ON THE TITLE PAGE

Item (30), Foreign Application Priority Data, "2002/287546" should read --2003-287546--, and "2003/021889" should read --2003-021889--.

COLUMN 6

Line 48, "substrate H110" should read --substrate H1110--.

Line 51, "substrate H110" should read --substrate H1110--.

COLUMN 13

Line 29, "it" should read --if--.

COLUMN 18

Line 16, "and" should be deleted.

Line 19, "substrate," should read --substrate;--.

Line 59, "and" should be deleted.

Line 62, "substrate," should read --substrate;--.

Signed and Sealed this

Fourth Day of March, 2008



JON W. DUDAS
Director of the United States Patent and Trademark Office